

## Silicon Carbide Power Schottky Diode

### Features

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of  $V_F$
- Extremely fast switching speeds
- Superior figure of merit  $Q_C/I_F$

### Package



TO – 220AC

$V_{RRM}$	=	1200 V
$I_F (T_c = 25^\circ C)$	=	12 A
$Q_C$	=	21 nC

### Advantages

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

### Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

### Maximum Ratings at $T_j = 175^\circ C$ , unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	$V_{RRM}$		1200	V
Continuous forward current	$I_F$	$T_c \leq 155^\circ C$	5	A
RMS forward current	$I_{F(RMS)}$	$T_c \leq 155^\circ C$	8	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_c = 25^\circ C, t_p = 10 \text{ ms}$ $T_c = 155^\circ C, t_p = 10 \text{ ms}$	32 26	A
Non-repetitive peak forward current	$I_{F,max}$	$T_c = 25^\circ C, t_p = 10 \mu\text{s}$	120	A
$I^2t$ value	$\int i^2 dt$	$T_c = 25^\circ C, t_p = 10 \text{ ms}$ $T_c = 155^\circ C, t_p = 10 \text{ ms}$	5 3.4	$\text{A}^2\text{s}$
Power dissipation	$P_{tot}$	$T_c = 25^\circ C$	117	W
Operating and storage temperature	$T_j, T_{stg}$		-55 to 175	$^\circ C$

### Electrical Characteristics at $T_j = 175^\circ C$ , unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	$V_F$	$I_F = 5 \text{ A}, T_j = 25^\circ C$	1.6	1.9	3.0	V
		$I_F = 5 \text{ A}, T_j = 175^\circ C$	2.6			
Reverse current	$I_R$	$V_R = 1200 \text{ V}, T_j = 25^\circ C$	5	50	100	$\mu\text{A}$
		$V_R = 1200 \text{ V}, T_j = 175^\circ C$	10			
Total capacitive charge	$Q_C$	$I_F \leq I_{F,MAX}$ $dI_F/dt = 200 \text{ A}/\mu\text{s}$ $T_j = 175^\circ C$	$V_R = 400 \text{ V}$ $V_R = 960 \text{ V}$	21 35		nC
Switching time	$t_s$		$V_R = 400 \text{ V}$ $V_R = 960 \text{ V}$	< 25		ns
Total capacitance	$C$	$V_R = 1 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	260			
		$V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	25			pF
		$V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	20			

### Thermal Characteristics

Thermal resistance, junction - case	$R_{thJC}$	1.4	$^\circ C/W$
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### Mechanical Properties

Mounting torque	M	0.6	Nm
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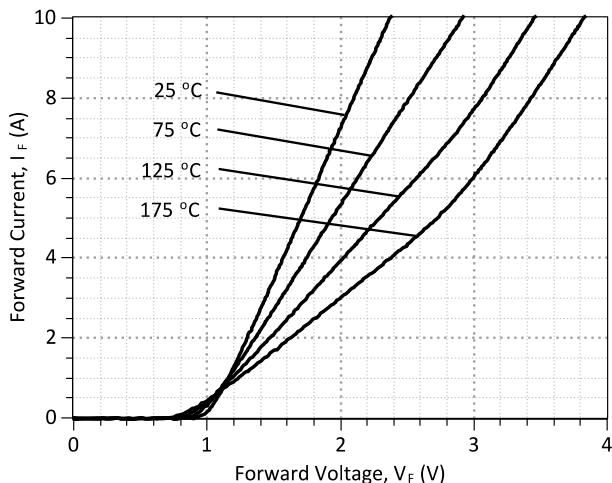


Figure 1: Typical Forward Characteristics

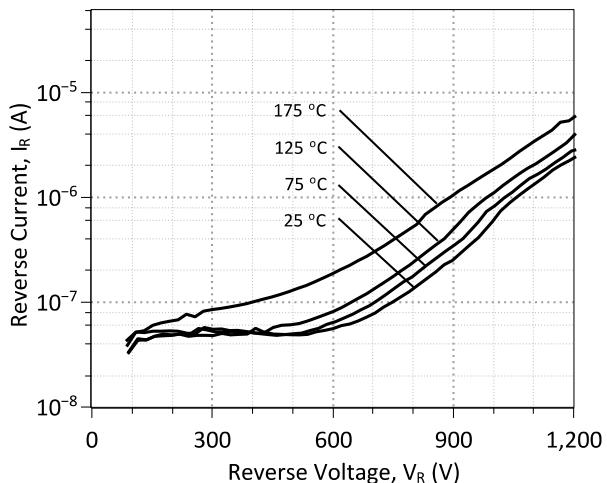


Figure 2: Typical Reverse Characteristics

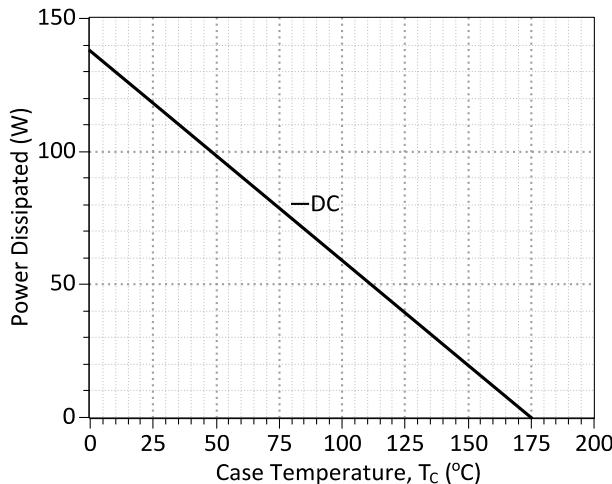


Figure 3: Power Derating Curve

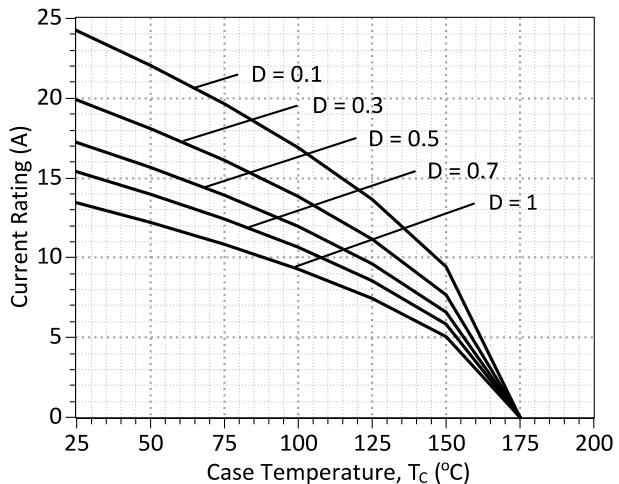


Figure 4: Current Derating Curves ( $D = t_p/T$ ,  $t_p = 400 \mu s$ )  
 (Considering worst case  $Z_{th}$  conditions )

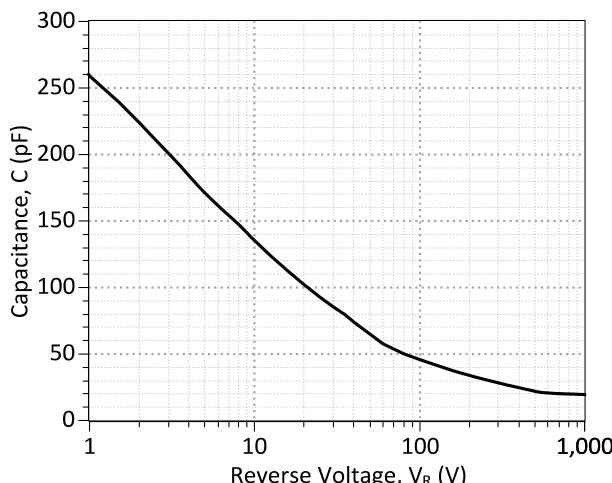


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

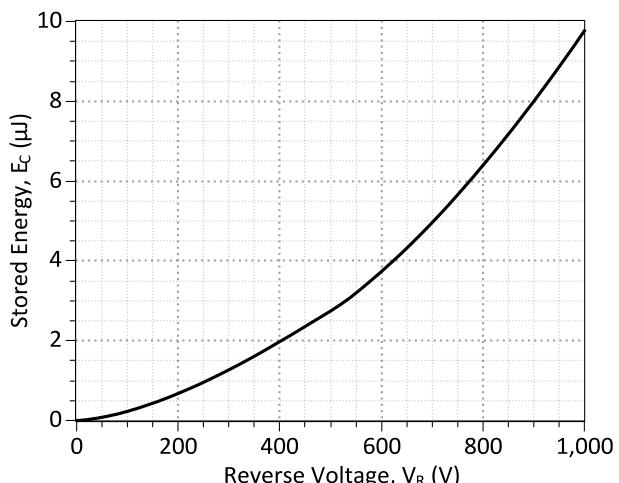


Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics

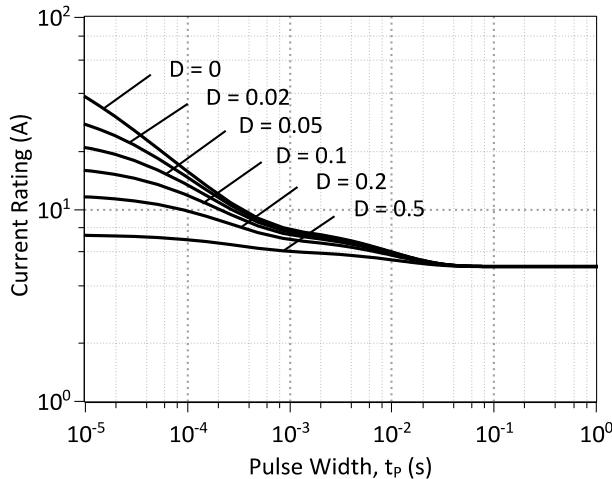


Figure 7: Current vs Pulse Duration Curves at  $T_c = 155 \text{ } ^\circ\text{C}$

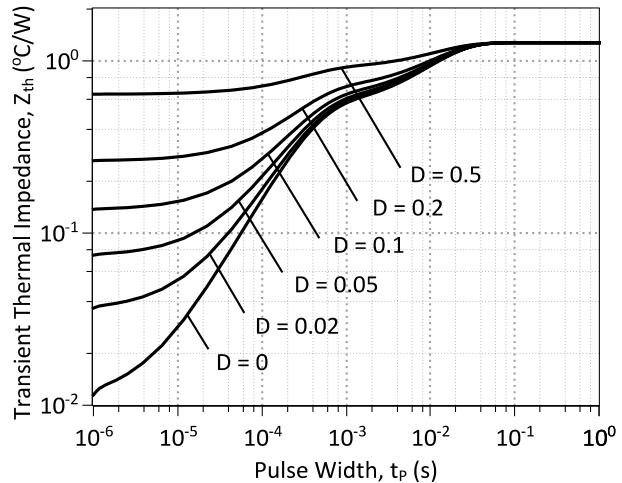
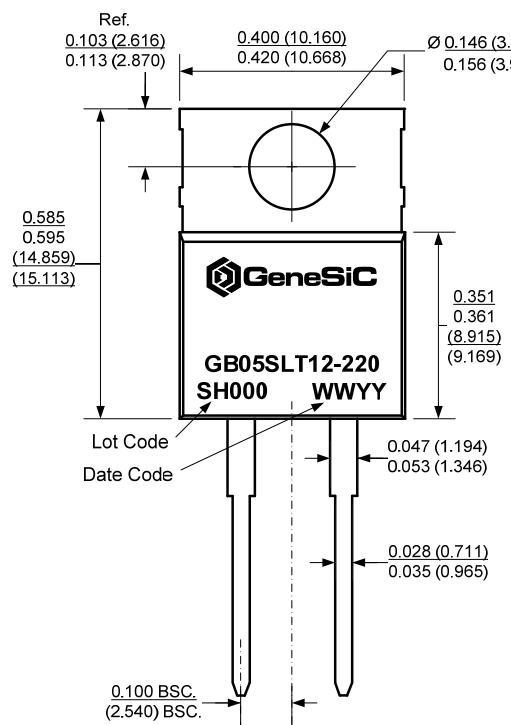


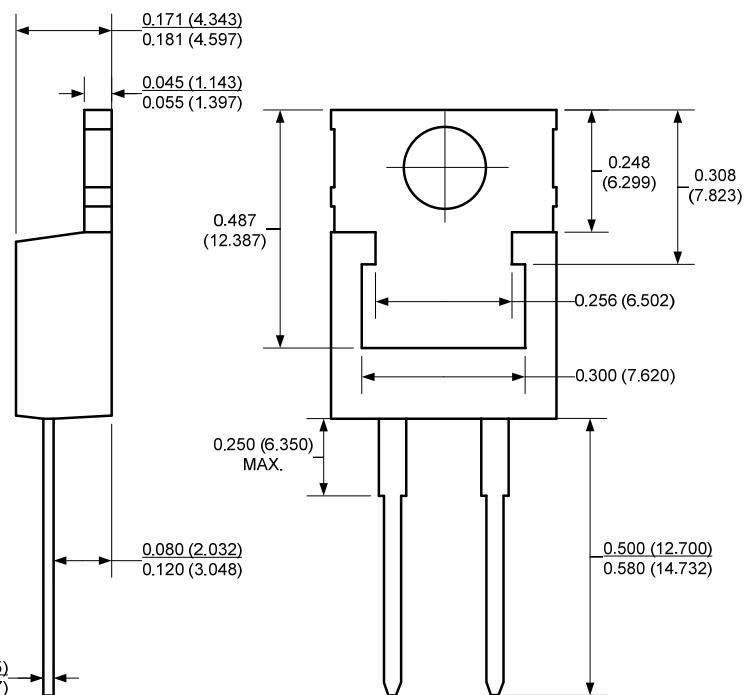
Figure 8: Transient Thermal Impedance

### Package Dimensions:

TO-220AC



PACKAGE OUTLINE



### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History			
Date	Revision	Comments	Supersedes
2014/08/26	3	Updated Electrical Characteristics	
2013/02/05	2	Second generation update	
2012/05/22	1	Second generation release	
2010/12/14	0	Initial release	

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## SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GB05SLT12-220 device.

```

*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:    1.0          $
*      $Date:      04-SEP-2013      $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*      http://www.genesicsemi.com/index.php/sic-products/schottky
*
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of GB05SLT12-220 SPICE Model
*
.SUBCKT GB05SLT12 ANODE KATHODE
R1 ANODE INT R=((TEMP-24)*0.0015); Temperature Dependant Resistor
D1 INT KATHODE GB05SLT12_25C; Call the 25C Diode Model
D2 ANODE KATHODE GB05SLT12_PIN; Call the PiN Diode Model
.MODEL GB05SLT12_25C D
+ IS      5.83E-18      RS      0.1276
+ N       1              IKF     602
+ EG      1.2            XTI     3
+ CJO     3.00E-10      VJ      0.419
+ M       1.6            FC      0.5
+ TT      1.00E-10      BV      1200
+ IBV     1.00E-03      VPK     1200
+ IAVE    5              TYPE    SiC_Schottky
+ MFG     GeneSiC_Semiconductor
.MODEL GB05SLT12_PIN D
+ IS      3.50 E-12      RS      0.3648
+ N       4.409           IKF     73
+ EG      3.23            XTI     -6
+ FC      0.5             TT      0
+ BV      1200            IBV     1.00E-03
+ VPK     1200            IAVE    1
+ TYPE    SiC_PiN
.ENDS
*
* End of GB05SLT12-220 SPICE Model

```

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